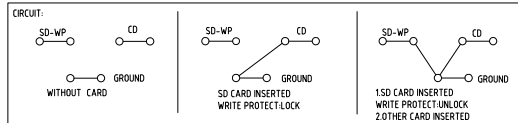


Pin No.		SD	MMSC
P1	MMC-DAT SD-DAT3	1P	7P
P2	MMC-CMD SD-CMD	2P	2P
P3	MMC-VSS1 SD-VSS1 接地	3P	3P
P4	MMC-VDD SD-VDD	4P	4P
P5	MMC-CLK SD-CLK	5P	5P
P6	MMC-VSS2 SD-VSS2 接地	6P	6P
P7	MMC-DAT SD-DAT0	7P	1P
P8	SD-DAT1	8P	
P9	SD-DAT2	9P	

PCB LAYOUT



SPECIFICATION

Electrical :

- Current Rating: 0.5mA AC / DC Max
- Voltage Rating: 125V AC / DC
- Contact Resistance: 100 mΩ Max.
- Insulation Resistance: 1,000 MΩ Min.

Environmental:

- Operating Temperature: -20°C ~ +90°C.

Material:

- Housing: LCP,Black
- Contact: Phosphor Bronze
- Shell: SUS

Finish:

- Contact: Plated Gold in Mating Area ;
Tin Plated on Solder Balls ;
Nickel under plated overall
- Shell: Nickel under Plated surface layer

ITEM NO.	DESCRIPTION	DRAWN	DATE
2	更新圖面	Jack	062419
1	更新圖面	Jack	081018

CONTACT 建倚科技股份有限公司
CONTACT TECHNOLOGY CORP.

TOLERANCE UNLESS OTHERWISE STATED :

Up to 5	±0.2
Above 5 ~ 15	±0.3
Above 15 ~ 30	±0.4
Above 30 ~ 50	±0.5
Angle	±0.3°

3RD. ANGEL'S

UNITS MM

DRAWN BY:	DATE	MAT'L	TITLE	CONNECTOR
Jack Lu	06/24/19			
CHECKED BY:	DATE	FINISH	MODLE	CARD CONNECTOR
Jacky Chen	06/24/19			
APPROVED BY:	DATE	SCALE	DWG NO.	SD-001-001-S267
Tony Kao	06/24/19	1 : 1		
		SHEET NO.	PART NO.	SD-001-001-S267
		1 of 1		
				SIZE A4
				VER R2